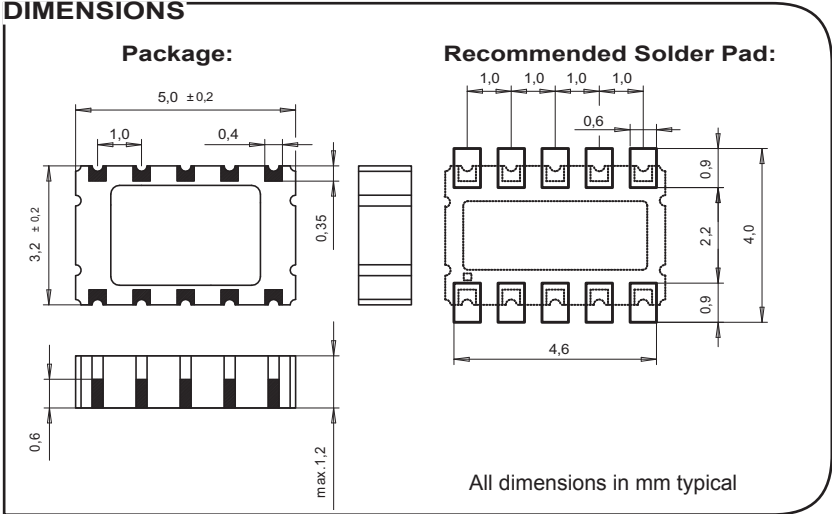
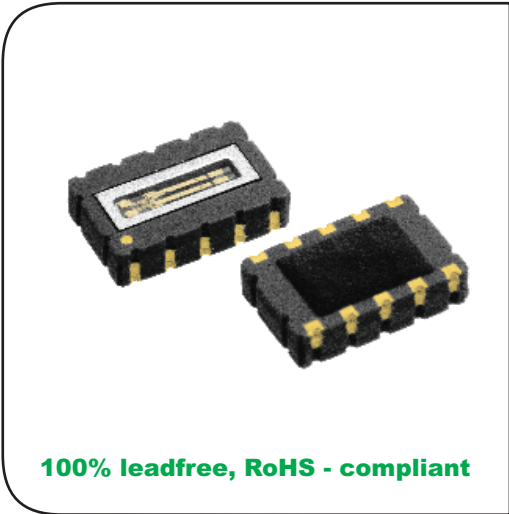


RV-2123-C2

Real Time Clock Module with SPI Bus



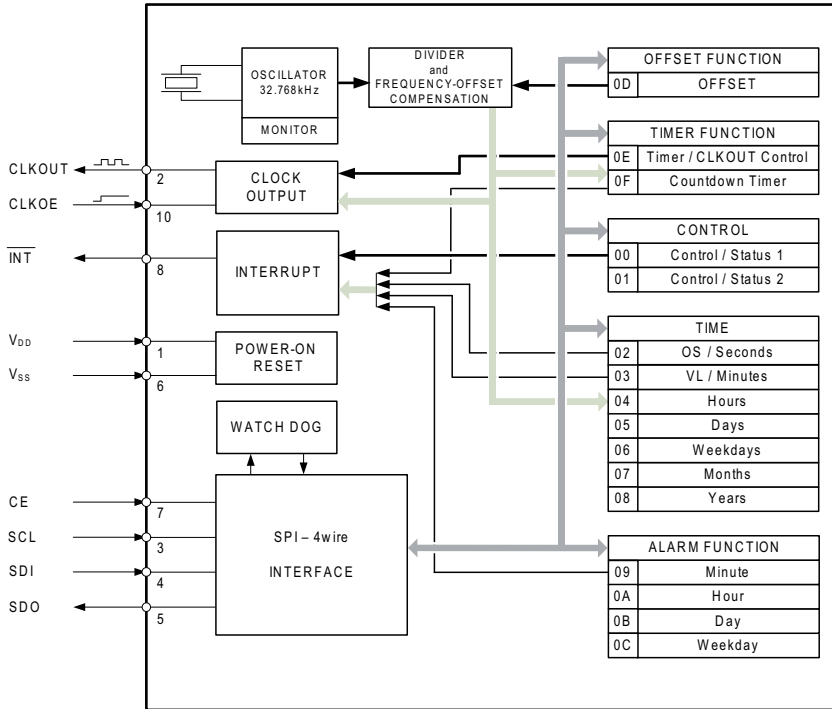
Ultra low power consumption 130nA
Automotive qualified, according to AEC-Q200 Rev. C
Xtal integrated solution.
Frequency-Offset Trimming Register
Miniature SMT ceramic package
Very tight frequency tolerance
SPI Bus Interface (SCL up to 8 MHz)
Programmable Clock-output
Low aging
Time keeping mode down to 1.1 V
Programmable alarm, timer and interrupt functions

DESCRIPTION:

This RTC IC has been specially designed to achieve an ultra-low power consumption of typically 130nA @ V_{DD} 3.0V in time-keeping mode. The very small SMT ceramic-package combines the 32.768 kHz crystal unit with the CMOS-based oscillator and real-time-clock circuitry. The calendar function tracks year, month, date, and day-of-the-week with built-in century and leap-year flags. The clock function tracks minute and second in 24-hour format. Programmable alarm setting and universal timer functions increase flexibility.

For pick-and-place equipment, the parts are available in 12 mm tape:
 7" (178 mm) reel with 1'000 parts
 13" (330 mm) reel with 5'000 parts

BLOCK DIAGRAM:



**ELECTRICAL CHARACTERISTICS
AT 25°C:**

| | Symbol | Condition | Min. | Typ. | Max | Unit |
|---------------------------------------|-------------------|----------------------------------|---|------|-----|------|
| Supply voltage | V _{DD} | SPI Bus Active | 1.6 | | 5.5 | V |
| Supply voltage | V _{DD} | Time keeping | 1.1 | | 5.5 | V |
| Current consumption during access | I _{DD} | fsc1=1 MHz V _{DD} 3 V | | 30 | 80 | μA |
| | | fsc1=4.5 MHz V _{DD} 3 V | | 250 | 400 | μA |
| Current consumption Time keeping mode | I _{DDO} | fsc1=0 Hz, V _{DD} 3 V | | 130 | 180 | nA |
| | | fsc1=0 Hz, V _{DD} 1 V | | 110 | 160 | nA |
| CLKOUT frequency | | Programmable | 32768...to...1 | | | Hz |
| Frequency tolerance | ΔF/F | @ 25°C | ±10 / ±20 ¹⁾ | | | ppm |
| Aging first year max. | ΔF/F | @ 25°C | ± 3 | | | ppm |
| Frequency vs. temp. | ΔF/F _O | 20 ≤ T ₀ ≤ 30 | -0.035 ppm/°C · (T - T ₀) ² ±10% | | | ppm |

1) Tighter and wider frequency tolerances on request.

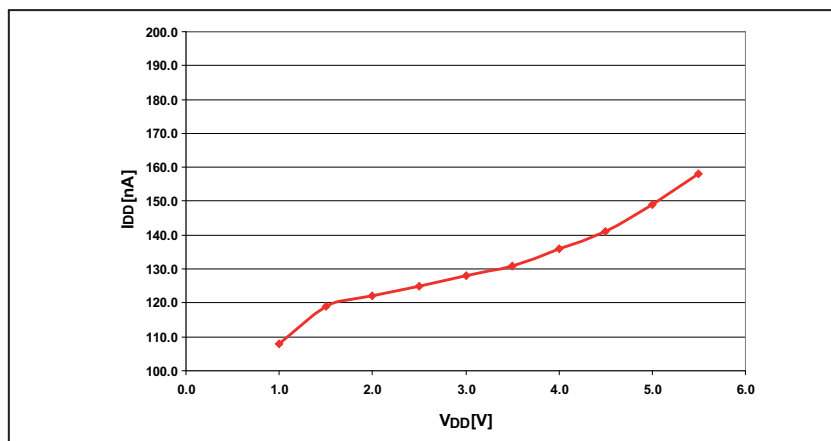
**ENVIRONMENTAL
CHARACTERISTICS:**

| | | Conditions | Max. Dev. |
|--------------------------------|------|------------------------|-----------|
| Storage temp. range | | -55 to +125°C | |
| TA Operating temperature range | | -40 to +85°C | |
| Shock resistance | ΔF/F | 5000 g, 0.3 ms, ½ sine | +/-5 ppm |
| Vibration resistance | ΔF/F | 20 g / 10–2000 Hz | +/-5 ppm |

**TERMINATIONS AND
PROCESSING:**

| Package-Type | Termination | Processing |
|--------------|------------------------------------|---------------------------------------|
| SON 10-pin | For SMD mounting Au plated pads | Reflow soldering 260°C / 20 s max. |

**CURRENT CONSUMPTION vs.
POWER SUPPLY VOLTAGE:**



**PIN CONNECTIONS
TOP VIEW:**

| Pin | Connection | |
|-----|-----------------|----------------------|
| 1 | V _{DD} | Power Supply Voltage |
| 2 | CLKOUT | Frequency output |
| 3 | SCL | Serial clock input |
| 4 | SDI | Serial Data In |
| 5 | SDO | Serial Data Out |
| 6 | V _{SS} | Ground |
| 7 | CE | Chip Enable |
| 8 | INT | Interrupt output |
| 9 | NC | not connected |
| 10 | CLKOE | CLK output enable |

All specifications subject to change without notice.



Micro Crystal AG
Mühlestrasse 14
CH-2540 Grenchen
Switzerland

Tel. +41 32 655 82 82
Fax +41 32 655 82 83
sales@microcrystal.com
www.microcrystal.com